



Pericom Semiconductor Corporation
3545 N. 1st St., San Jose, CA 95134 U.S.A.

TO: All Pericom Customers

DATE: January 31, 2008

SUBJECT: Non-Use of Halogenated Flame Retardants in Green/Pb-free Products

Along with removing Pb in our product's solder plated terminals used with our Green/Pb-free packages, Pericom also eliminated other potentially hazardous chemicals/materials that are or will be banned by most countries. The two types of most concern are Antimony Trioxide (Sb₂O₃) and Bromine (TBBP-A), which are halogenated flame-retardants used in the package's epoxy mold compound. Alternative formulations have been developed by the major mold compound manufacturers Pericom utilizes for our plastic encapsulated packages, and are used with all our Green/Pb-free products identified with an "E" after the package code letter.

If there are any questions or more information needed on this issue, please contact me at your convenience.

Regards,

Edward J. Mello Jr.
Director, Quality Systems
Pericom Semiconductor Corporation
Phone: (408) 435-0800 Ext. 207
E-mail: emello@pericom.com
